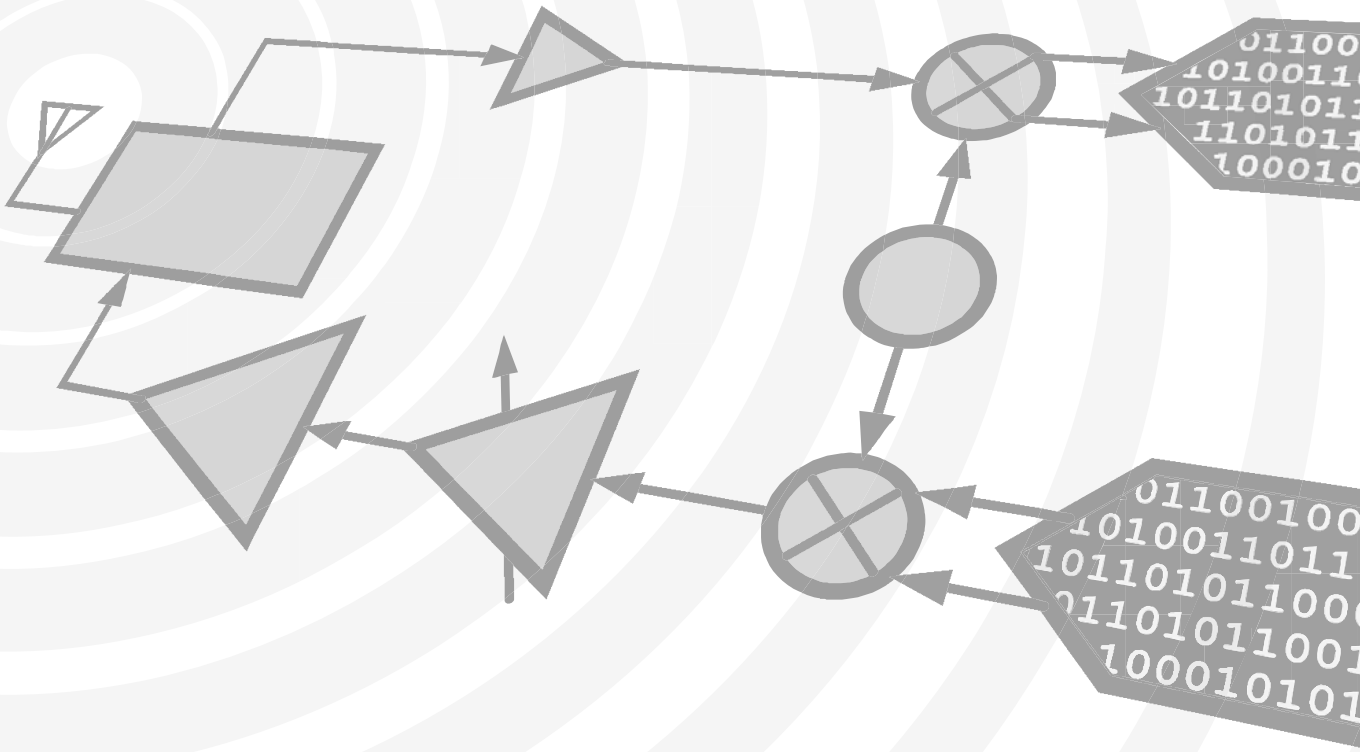
ANALOG DEVICES

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www.analog.com

www.hittite.com

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HMC452ST89 / 452ST89E

v02.0710

InGaP HBT 1 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

RoHS✓ EARTH FRIENDLY

Designer's Kit Available

Typical Applications

The HMC452ST89 / HMC452ST89E is ideal for applications requiring a high dynamic range amplifier:

- GSM, GPRS & EDGE
- CDMA & W-CDMA
- CATV/Cable Modem
- Fixed Wireless

Features

Output IP3: +49 dBm

21 dB Gain @ 400 MHz

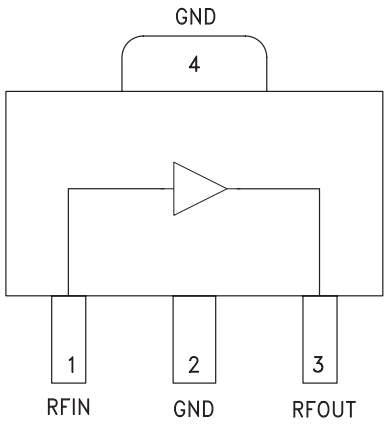
9 dB Gain @ 2100 MHz

50% PAE @ +31 dBm Pout

+25 dBm CDMA2000 Channel Power @ -45 dBc ACP

Included in the HMC-DK002 Designer's Kit

Functional Diagram



General Description

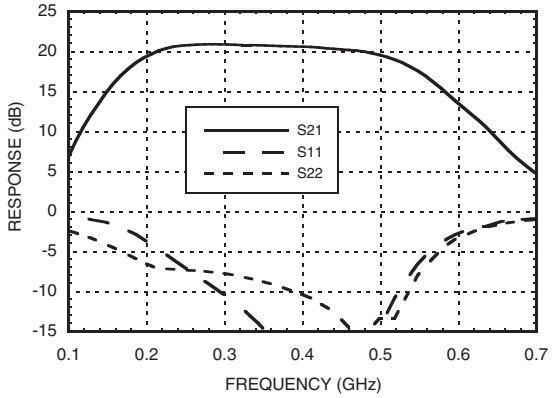
The HMC452ST89 & HMC452ST89E are high dynamic range GaAs InGaP HBT 1 Watt MMIC power amplifiers operating from 0.4 to 2.2 GHz and packaged in industry standard SOT89 packages. Utilizing a minimum number of external components and a single +5V supply, the amplifier output IP3 can be optimized to +45 dBm at 0.4 GHz or +49 dBm at 2.1 GHz. The high output IP3 and PAE make the HMC452ST89 & HMC452ST89E ideal power amplifiers for Cellular/ PCS/3G and Fixed Wireless applications.

Electrical Specifications, T_A = +25°C, Vs= +5V [1]

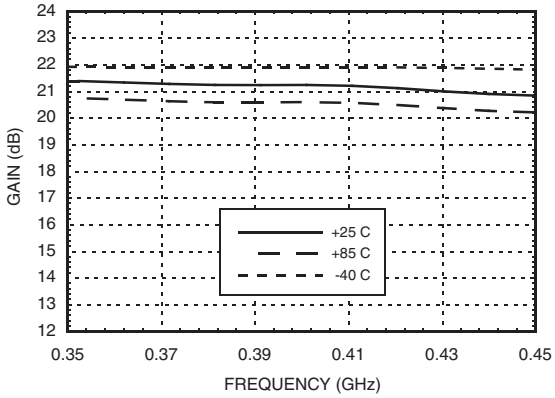
Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	400 - 410			450 - 496			810 - 960			1710 - 1990			2010 - 2170			MHz
Gain	19	21		18	20		13.5	15.5		7	9.5		7	9		dB
Gain Variation Over Temperature		0.012	0.02		0.012	0.02		0.012	0.02		0.012	0.02		0.012	0.02	dB / °C
Input Return Loss		22			16			13			13			20		dB
Output Return Loss		11			11			14			15			15		dB
Output Power for 1dB Compression (P1dB)	27	30		27	30		27.5	30.5		28	31		28.5	31.5		dBm
Saturated Output Power (Psat)		30.5			30.5			31.5			31.5			32		dBm
Output Third Order Intercept (IP3) [2]	42	45		42	45		44	47		45	48		46	49		dBm
Noise Figure		6.5			7			6.5			6.5			6.5		dB
Supply Current (Icq)		510			510			510			510			510		mA

[1] Specifications and data reflect HMC452ST89 measured using the respective application circuits for each designated frequency band found herein. Contact the HMC Applications Group for assistance in optimizing performance for your application.
[2] Two-tone input power of 0 dBm per tone, 1 MHz spacing.

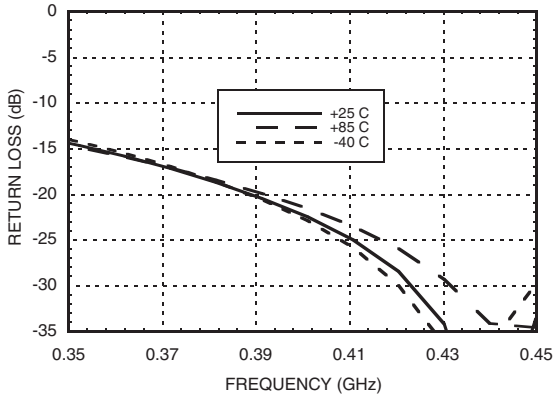
Broadband Gain & Return Loss @ 400 MHz



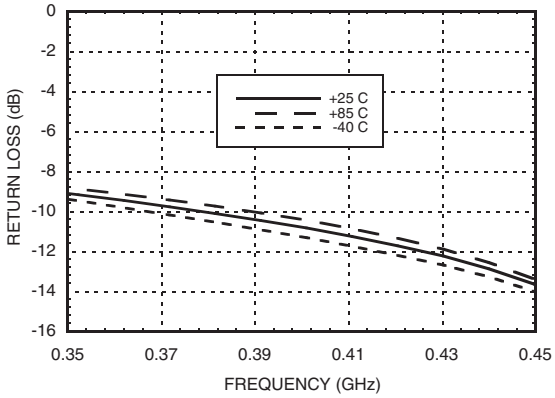
Gain vs. Temperature @ 400 MHz



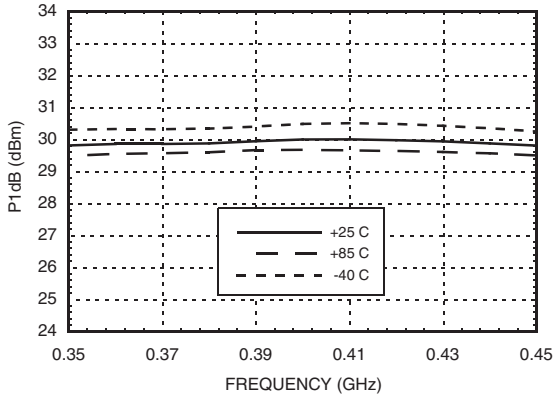
Input Return Loss vs. Temperature @ 400 MHz



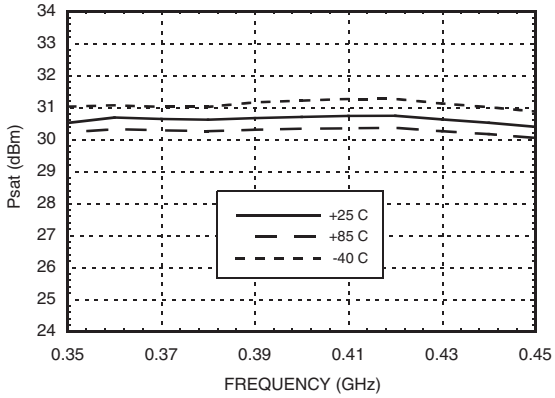
Output Return Loss vs. Temperature @ 400 MHz



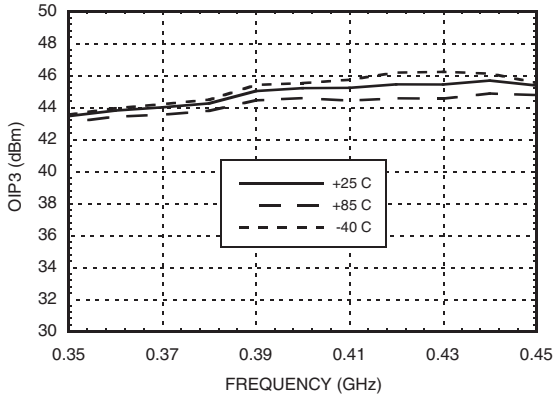
P1dB vs. Temperature @ 400 MHz



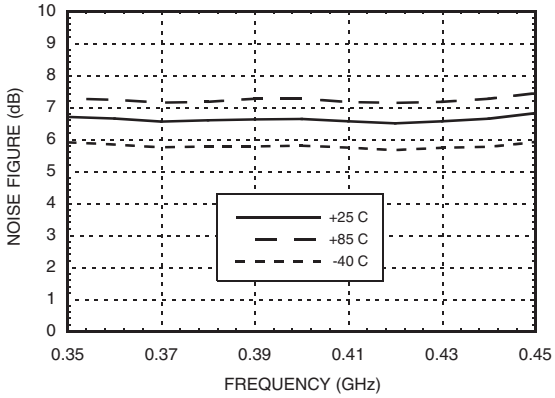
Psat vs. Temperature @ 400 MHz



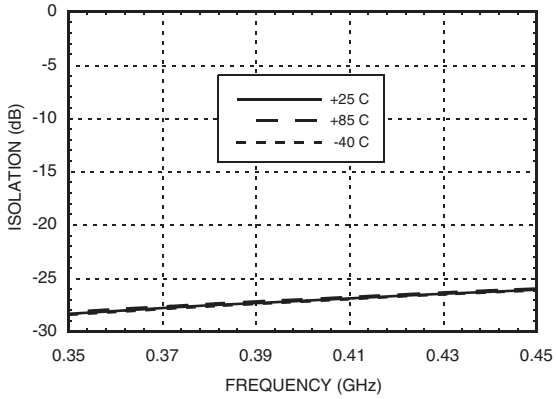
Output IP3 vs. Temperature @ 400 MHz



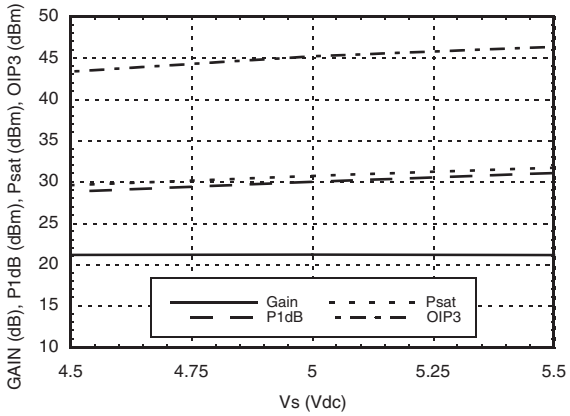
Noise Figure vs. Temperature @ 400 MHz



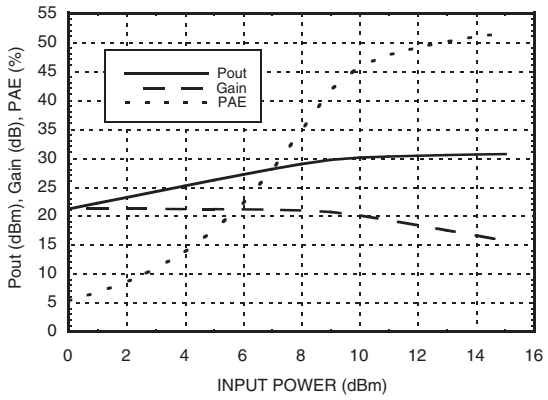
Reverse Isolation vs. Temperature @ 400 MHz



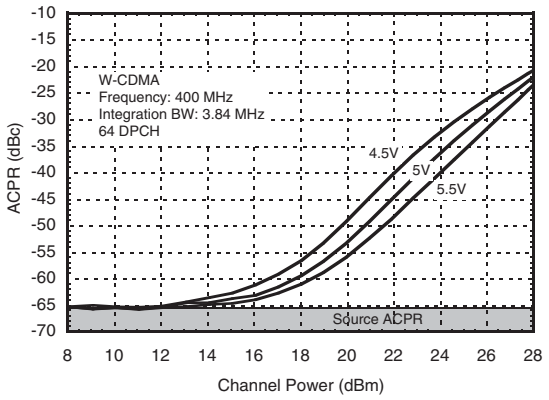
Gain, Power & IP3 vs. Supply Voltage @ 400 MHz



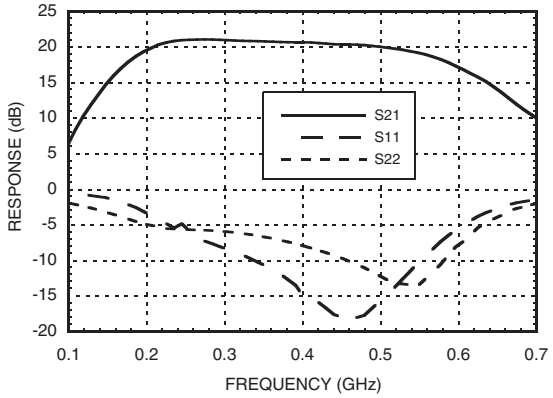
Power Compression @ 400 MHz



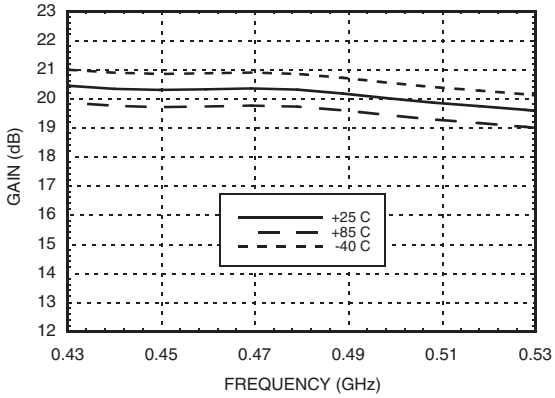
ACPR vs. Supply Voltage @ 400 MHz W-CDMA, 64 DPCH



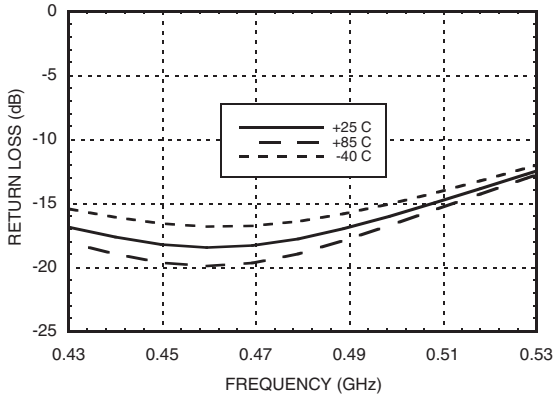
Broadband Gain & Return Loss @ 470 MHz



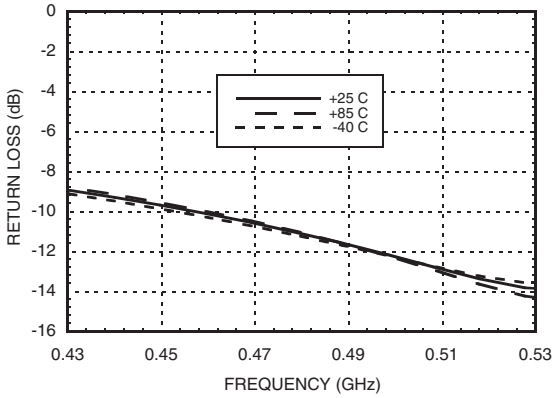
Gain vs. Temperature @ 470 MHz



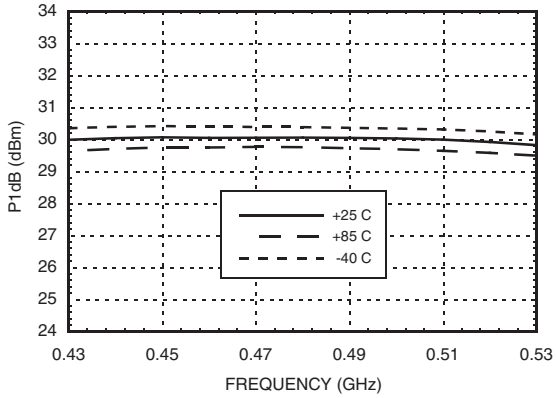
Input Return Loss vs. Temperature @ 470 MHz



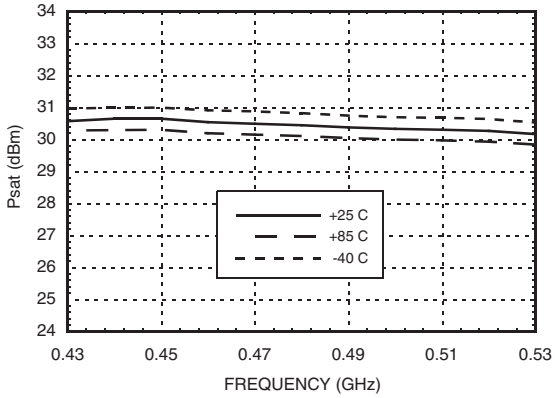
Output Return Loss vs. Temperature @ 470 MHz



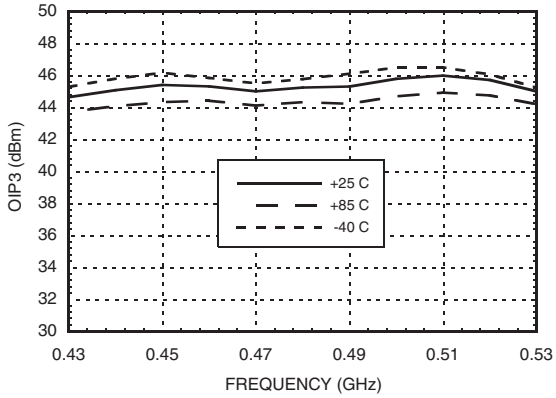
P1dB vs. Temperature @ 470 MHz



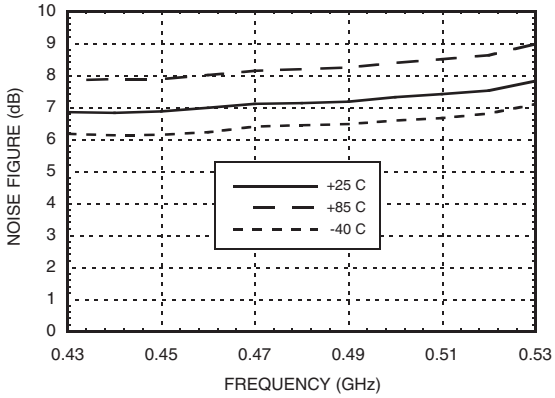
Psat vs. Temperature @ 470 MHz



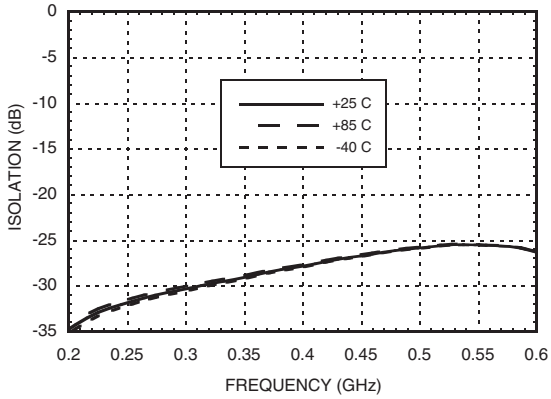
Output IP3 vs. Temperature @ 470 MHz



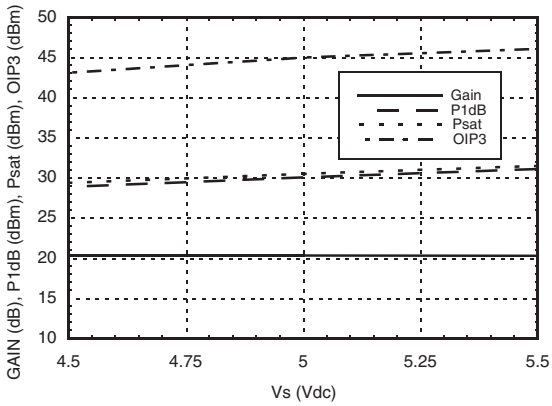
Noise Figure vs. Temperature @ 470 MHz



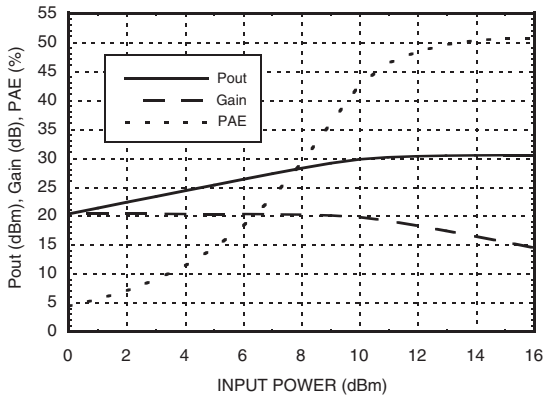
Reverse Isolation vs. Temperature @ 470 MHz



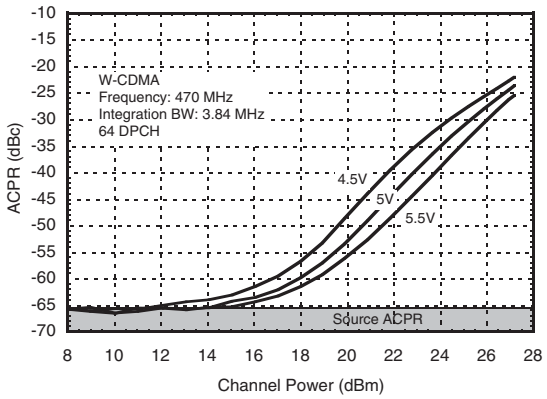
Gain, Power & IP3 vs. Supply Voltage @ 470 MHz



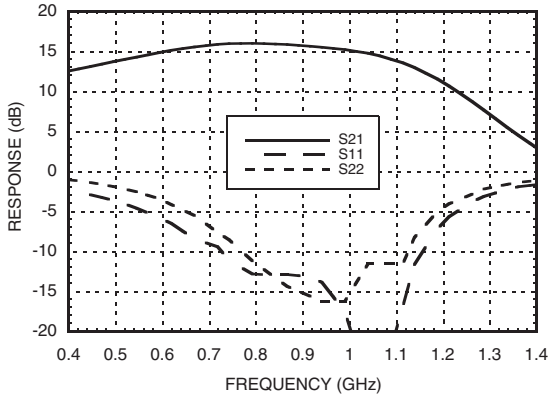
Power Compression @ 470 MHz



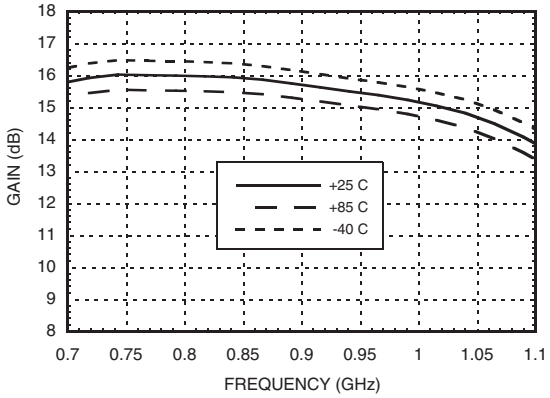
ACPR vs. Supply Voltage @ 470 MHz W-CDMA, 64 DPCH



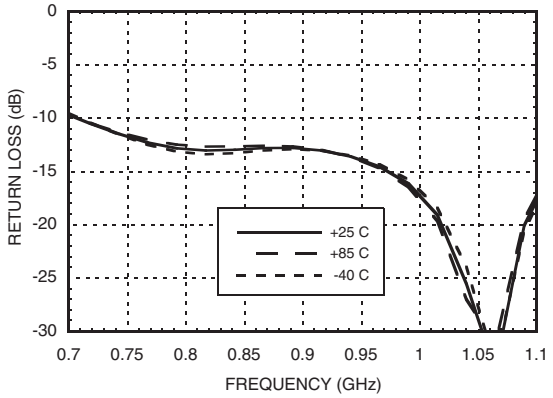
Broadband Gain & Return Loss @ 900 MHz



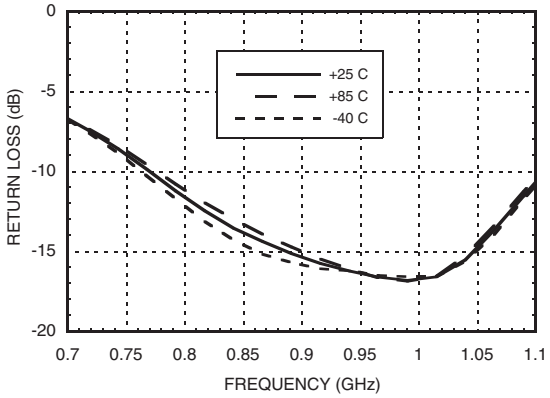
Gain vs. Temperature @ 900 MHz



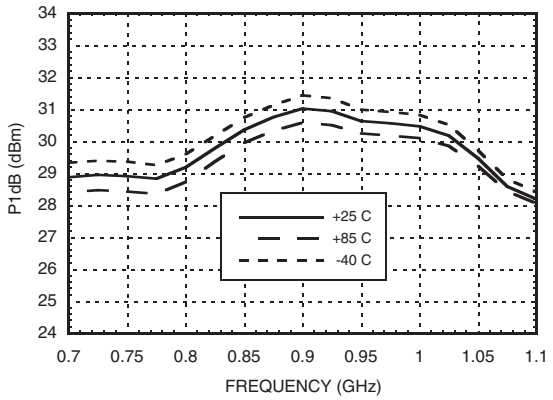
Input Return Loss vs. Temperature @ 900 MHz



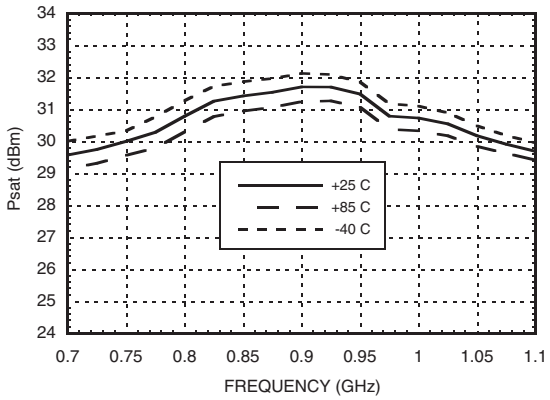
Output Return Loss vs. Temperature @ 900 MHz



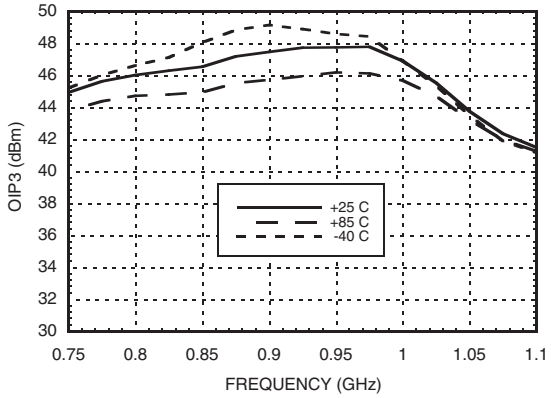
P1dB vs. Temperature @ 900 MHz



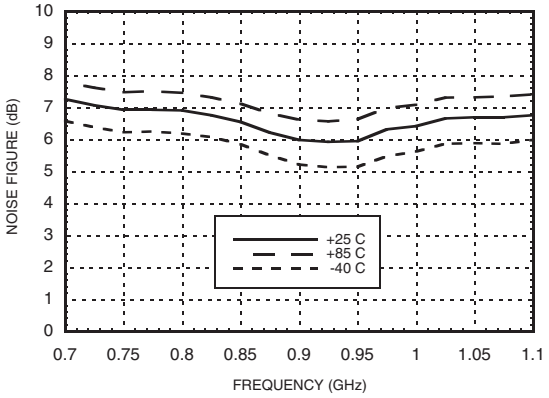
Psat vs. Temperature @ 900 MHz



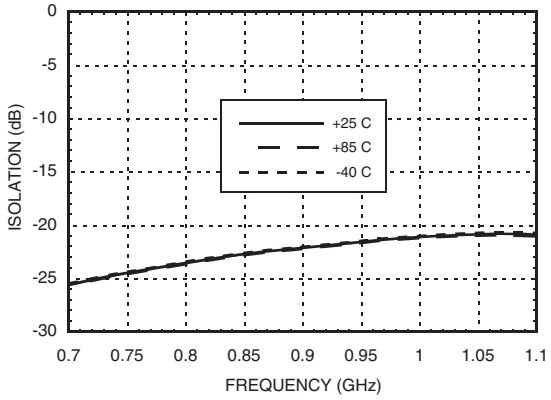
Output IP3 vs. Temperature @ 900 MHz



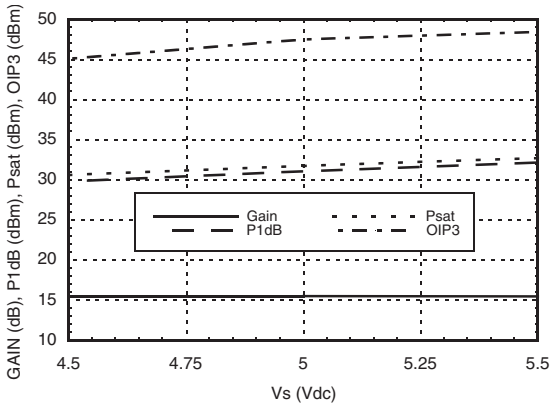
Noise Figure vs. Temperature @ 900 MHz



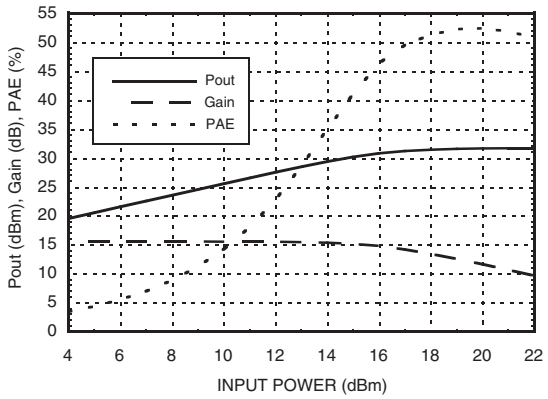
Reverse Isolation vs. Temperature @ 900 MHz



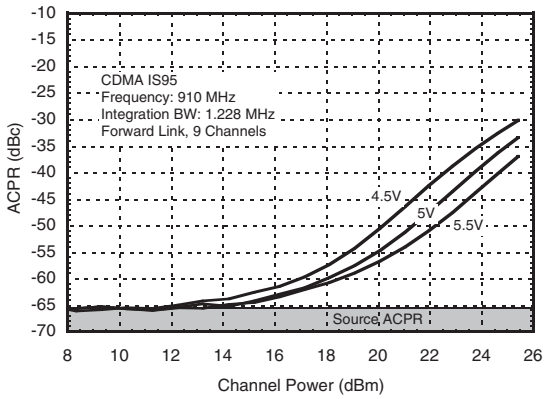
Gain, Power & IP3 vs. Supply Voltage @ 900 MHz



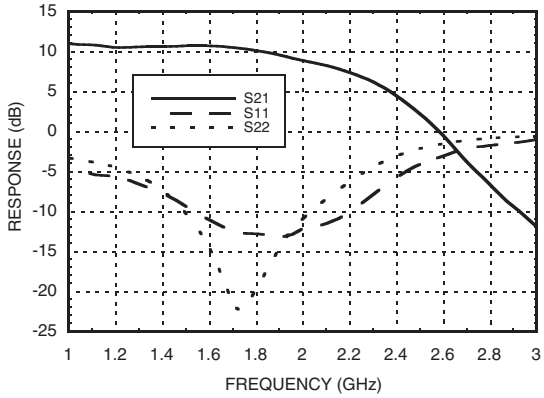
Power Compression @ 900 MHz



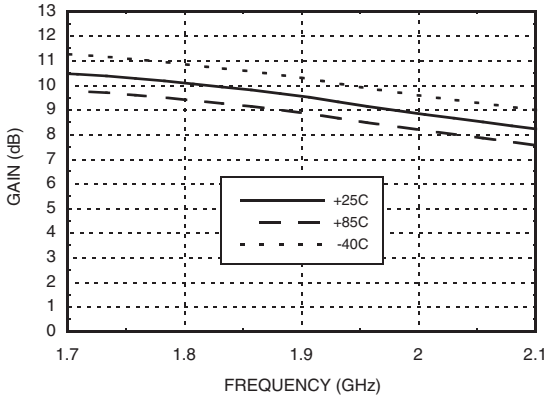
ACPR vs. Supply Voltage @ 910 MHz CDMA IS95, 9 Channels Forward



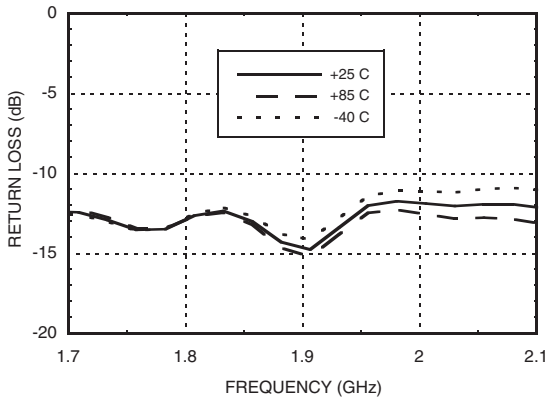
Broadband Gain & Return Loss @ 1900 MHz



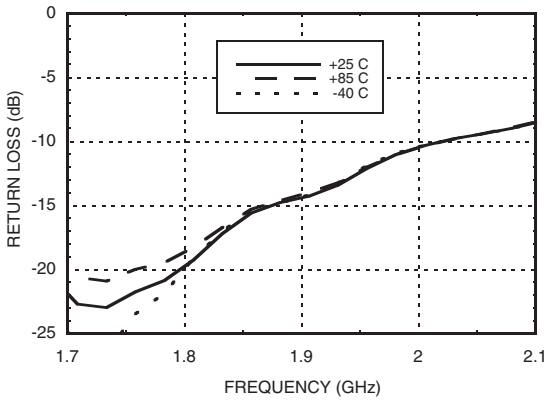
Gain vs. Temperature @ 1900 MHz



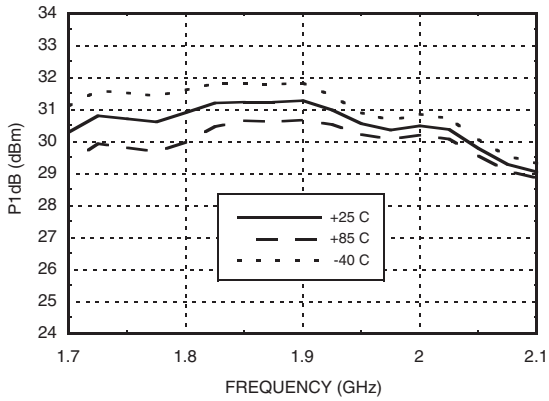
Input Return Loss vs. Temperature @ 1900 MHz



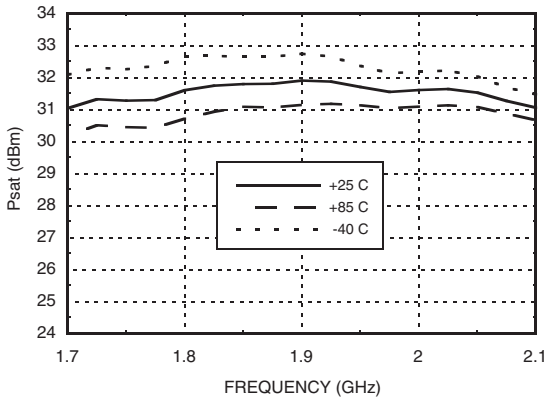
Output Return Loss vs. Temperature @ 1900 MHz



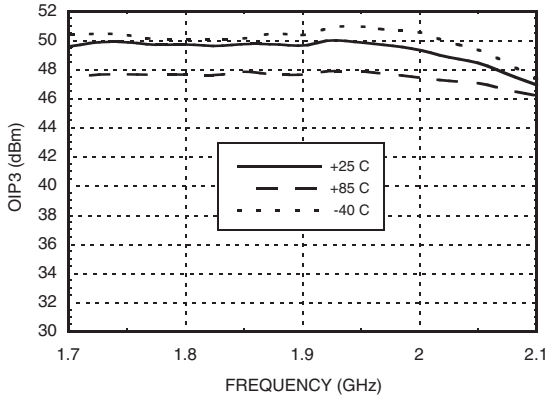
P1dB vs. Temperature @ 1900 MHz



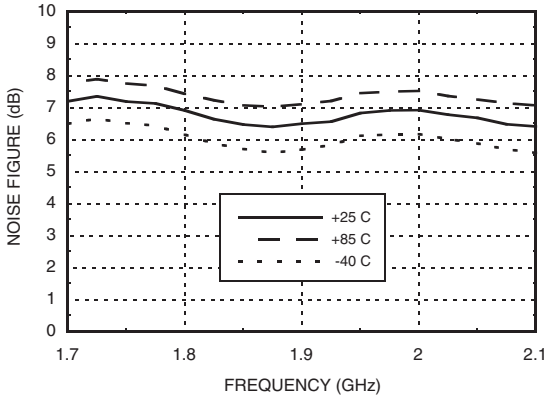
Psat vs. Temperature @ 1900 MHz



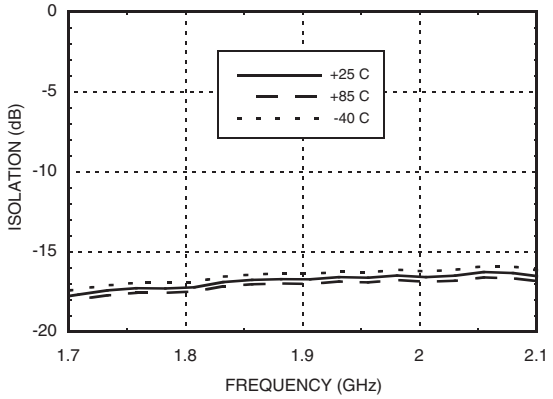
Output IP3 vs. Temperature @ 1900 MHz



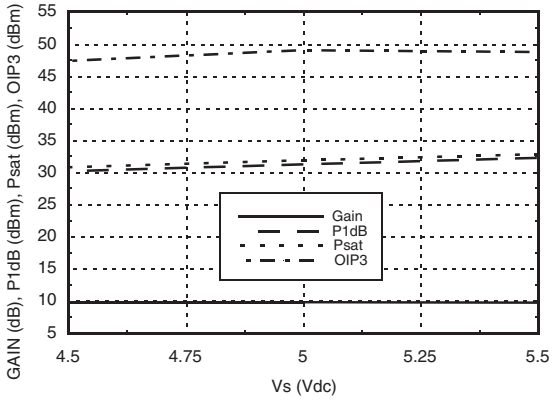
Noise Figure vs. Temperature @ 1900 MHz



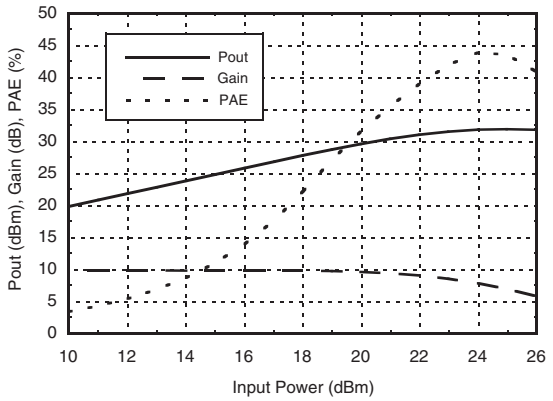
Reverse Isolation vs. Temperature @ 1900 MHz



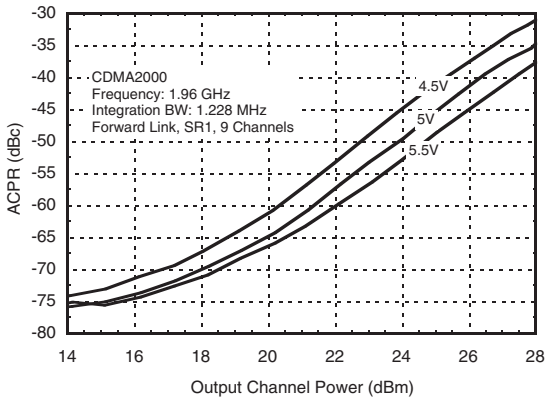
Gain, Power & IP3 vs. Supply Voltage @ 1900 MHz



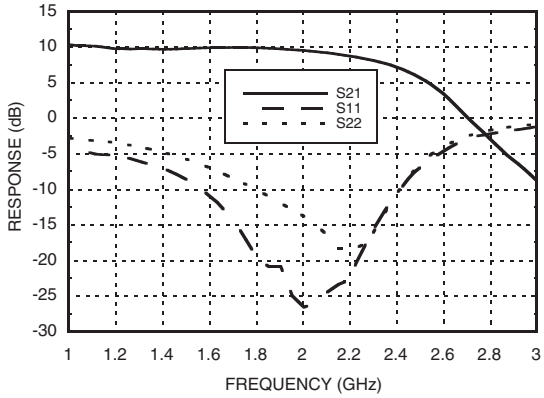
Power Compression @ 1900 MHz



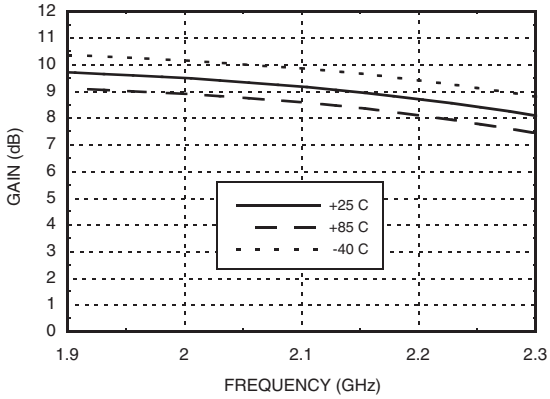
ACPR vs. Supply Voltage @ 1960 MHz CDMA 2000, 9 Channels Forward



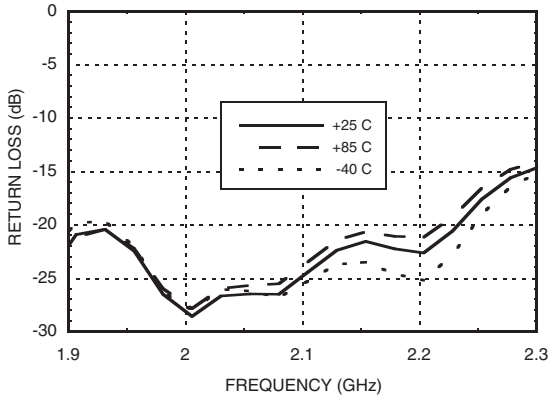
Broadband Gain & Return Loss @ 2100 MHz



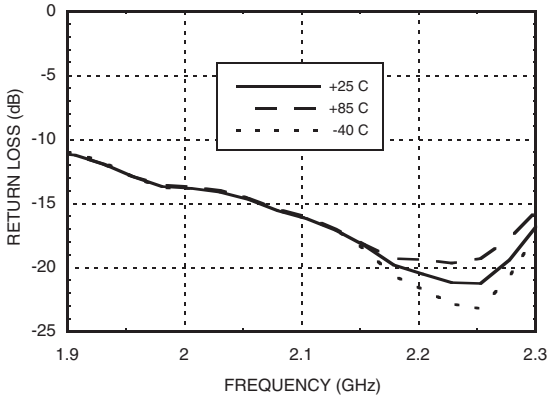
Gain vs. Temperature @ 2100 MHz



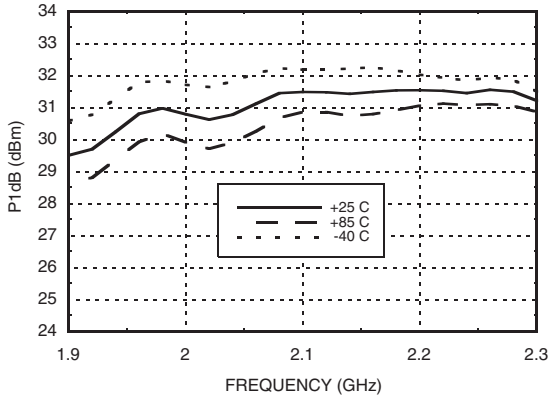
Input Return Loss vs. Temperature @ 2100 MHz



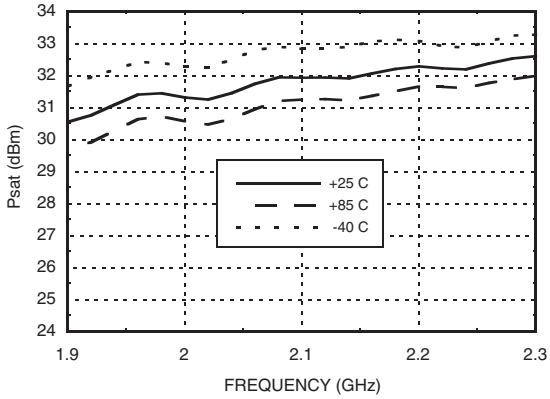
Output Return Loss vs. Temperature @ 2100 MHz



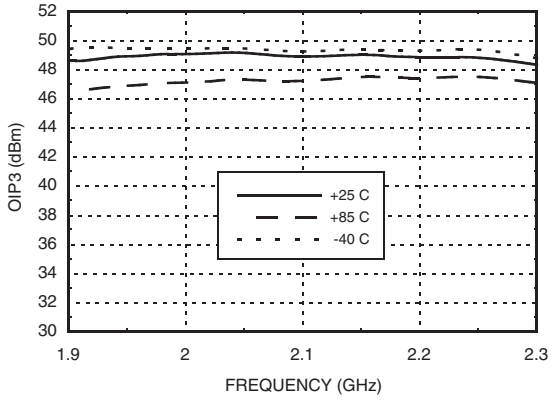
P1dB vs. Temperature @ 2100 MHz



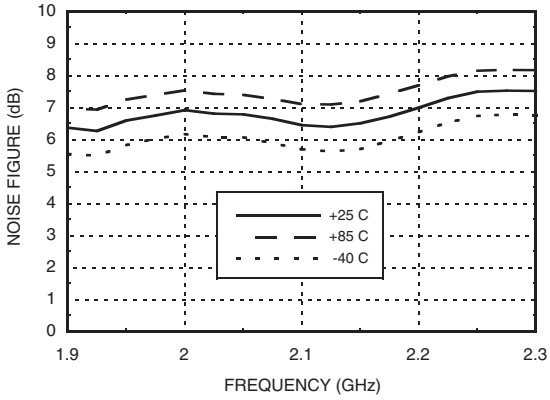
Psat vs. Temperature @ 2100 MHz



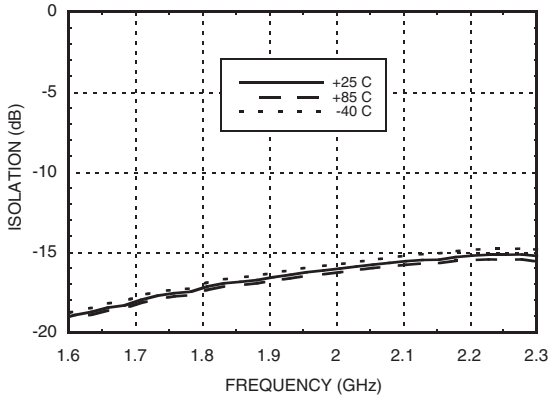
Output IP3 vs. Temperature @ 2100 MHz



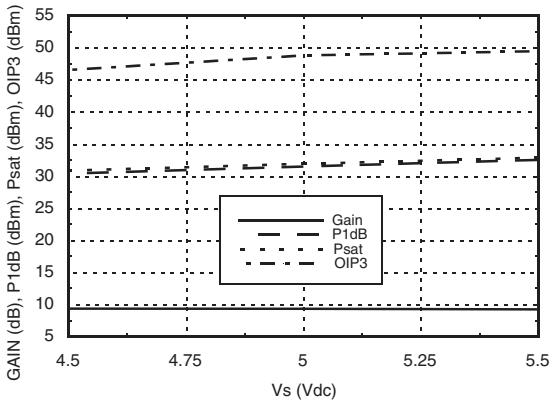
Noise Figure vs. Temperature @ 2100 MHz



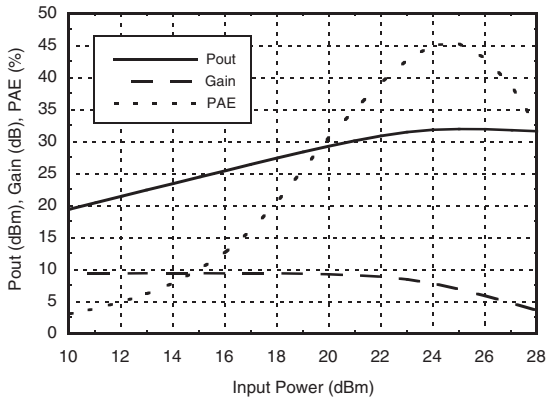
Reverse Isolation vs. Temperature @ 2100 MHz



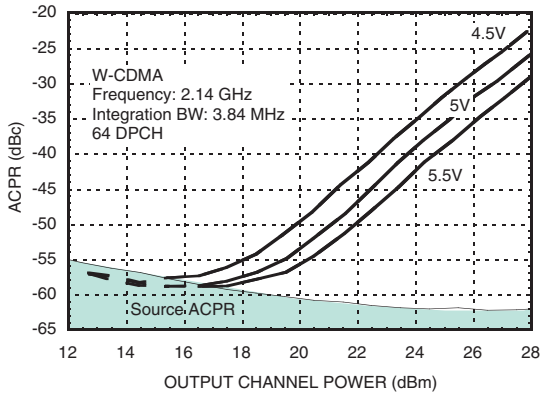
Gain, Power & IP3 vs. Supply Voltage @ 2100 MHz



Power Compression @ 2100 MHz



ACPR vs. Supply Voltage @ 2140 MHz W-CDMA, 64 DPCH

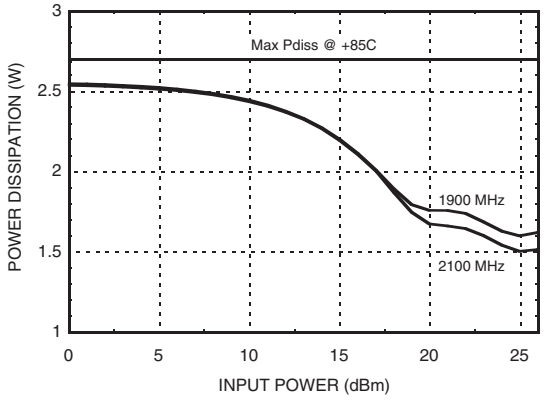


For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824
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Application Support: Phone: 978-250-3343 or apps@hittite.com

HMC452ST89 / 452ST89E

InGaP HBT 1 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

Power Dissipation

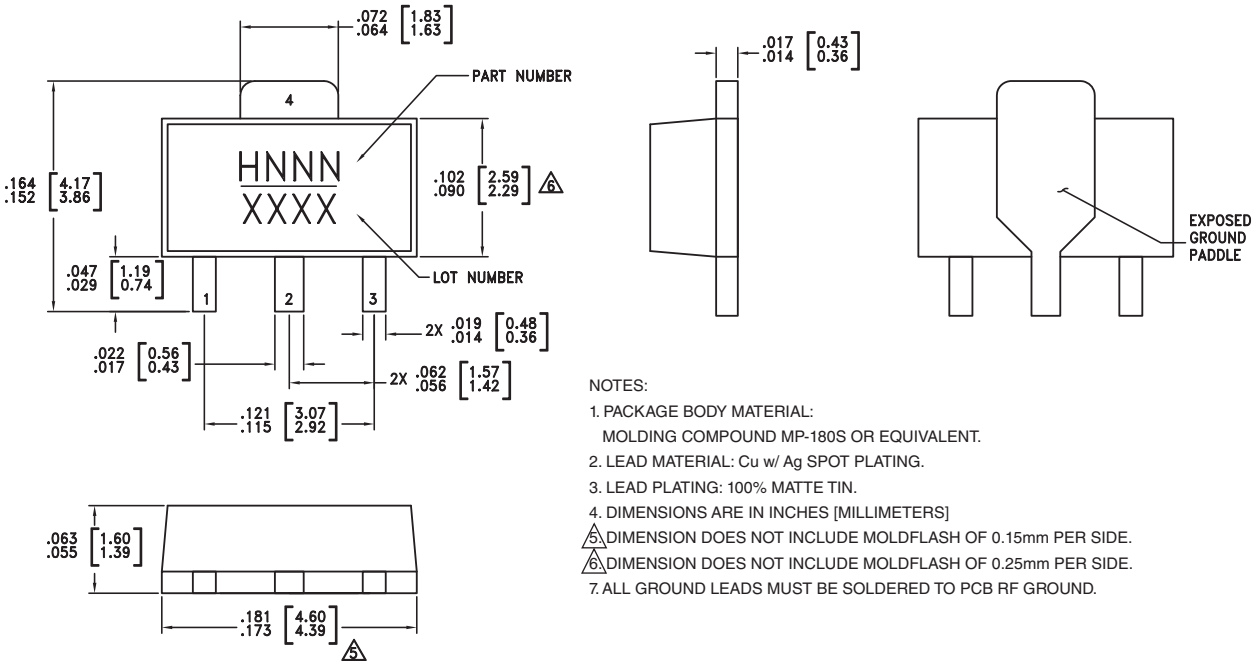


Absolute Maximum Ratings

Collector Bias Voltage (Vcc)	+6.0 Vdc
RF Input Power (RFIN)(Vs +5Vdc)	+31 dBm
Junction Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 41.5 mW/°C above 85 °C)	2.7 W
Thermal Resistance (junction to ground paddle)	24.1 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

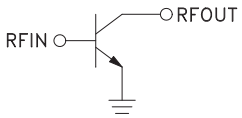
1. PACKAGE BODY MATERIAL:
   MOLDING COMPOUND MP-180S OR EQUIVALENT.
2. LEAD MATERIAL: Cu w/ Ag SPOT PLATING.
3. LEAD PLATING: 100% MATTE TIN.
4. DIMENSIONS ARE IN INCHES [MILLIMETERS]
5. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
6. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC452ST89	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H452 XXXX
HMC452ST89E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H452 XXXX

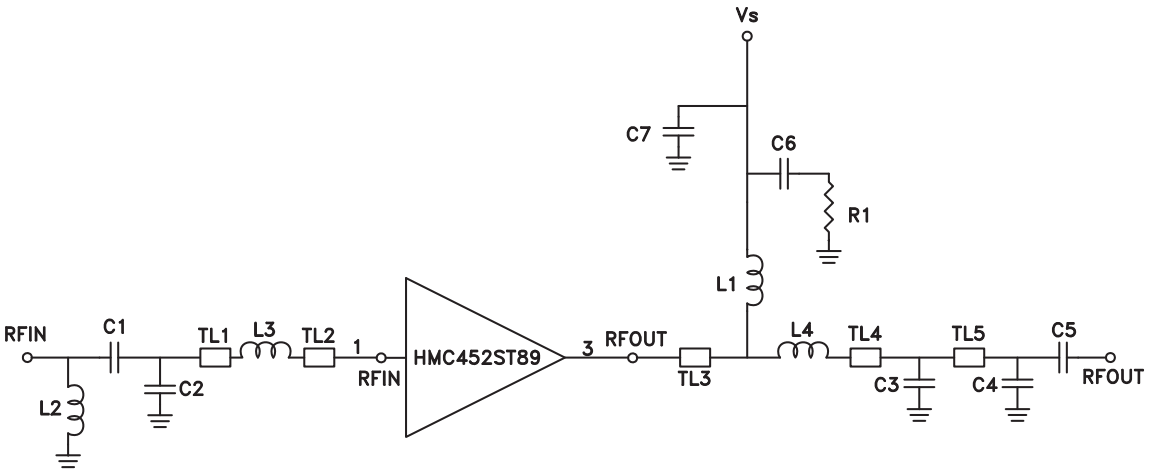
[1] Max peak reflow temperature of 235 °C
[2] Max peak reflow temperature of 260 °C
[3] 4-Digit lot number XXXX

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	RFIN	This pin is DC coupled. Off chip matching components are required. See Application Circuit herein.	
3	RFOUT	RF output and DC Bias input for the output amplifier stage. Off chip matching components are required. See Application Circuit herein.	
2, 4	GND	These pins & package bottom must be connected to RF/DC ground.	

400 MHz Application Circuit

This circuit was used to specify the performance for 400-410 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

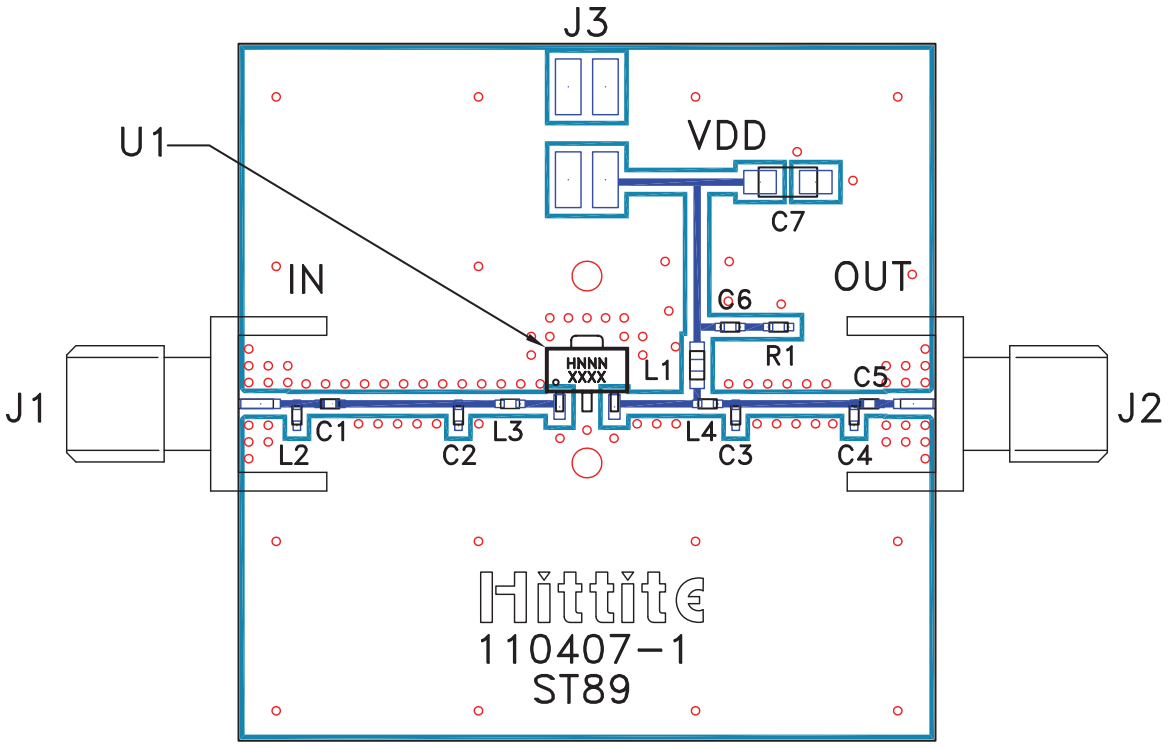


Note: C2 should be placed as close to pins as possible.

	TL1	TL2	TL3	TL4	TL5
Impedance	50 Ohm	50 Ohm	50 Ohm	50 Ohm	50 Ohm
Physical Length	0.09"	0.08"	0.17"	0.04"	0.25"
Electrical Length	2°	2°	4°	1°	6°
PCB Material: 10 mil Rogers 4350, Er = 3.48					

Recommended Component Values	
C1	12 pF
C2	15 pF
C3, C4	6.8 pF
C5	39 pF
C6	100 pF
C7	2.2 µF
L1	47 nH
L2	40 nH
L3	4.3 nH
L4	5.1 nH
R1	5.1 Ohm

400 MHz Evaluation PCB



List of Materials for Evaluation PCB 110409-400 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	12 pF Capacitor, 0402 Pkg.
C2	15 pF Capacitor, 0402 Pkg.
C3, C4	6.8 pF Capacitor, 0402 Pkg.
C5	39 pF Capacitor, 0402 Pkg.
C6	100 pF Capacitor, 0402 Pkg.
C7	2.2 µF Capacitor, Tantalum
L1	47 nH Inductor, 0603 Pkg.
L2	40 nH Inductor, 0402 Pkg.
L3	4.3 nH Inductor, 0402 Pkg.
L4	5.1 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC452ST89 / HMC452ST89E Linear Amp
PCB [2]	110407 Evaluation PCB, 10 mils

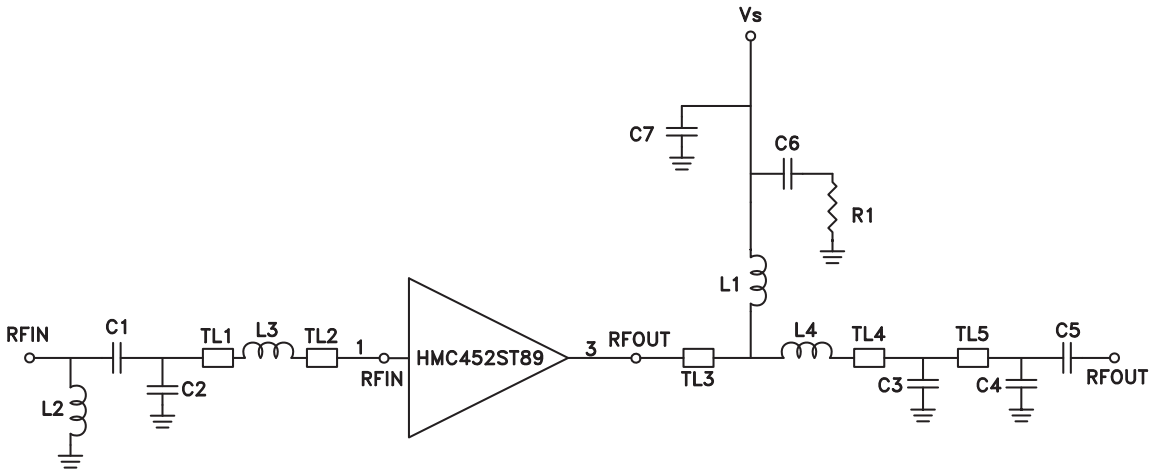
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

470 MHz Application Circuit

This circuit was used to specify the performance for 450-496 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

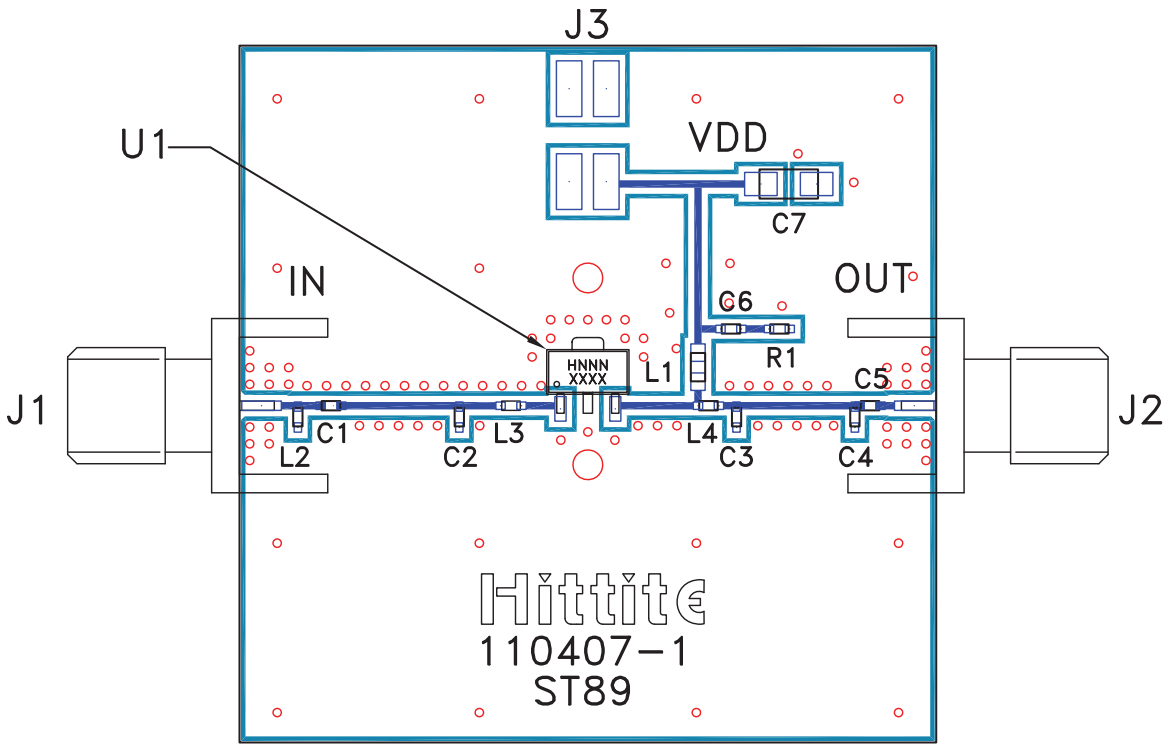


Note: C2 should be placed as close to pins as possible.

	TL1	TL2	TL3	TL4	TL5
Impedance	50 Ohm	50 Ohm	50 Ohm	50 Ohm	50 Ohm
Physical Length	0.09"	0.08"	0.17"	0.04"	0.25"
Electrical Length	2.5°	2°	5°	1°	7°
PCB Material: 10 mil Rogers 4350, Er = 3.48					

Recommended Component Values	
C1, C2	12 pF
C3	6.8 pF
C4	5.6 pF
C5	39 pF
C6	100 pF
C7	2.2 µF
L1	47 nH
L2	40 nH
L3	4.7 nH
L4	3.9 nH
R1	5.1 Ohm

470 MHz Evaluation PCB



List of Materials for Evaluation PCB 110416-470 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1, C2	12 pF Capacitor, 0402 Pkg.
C3	6.8 pF Capacitor, 0402 Pkg.
C4	5.6 pF Capacitor, 0402 Pkg.
C5	39 pF Capacitor, 0402 Pkg.
C6	100 pF Capacitor, 0402 Pkg.
C7	2.2 µF Capacitor, Tantalum
L1	47 nH Inductor, 0603 Pkg.
L2	40 nH Inductor, 0402 Pkg.
L3	4.7 nH Inductor, 0402 Pkg.
L4	3.9 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC452ST89 / HMC452ST89E Linear Amp
PCB [2]	110407 Evaluation PCB, 10 mils

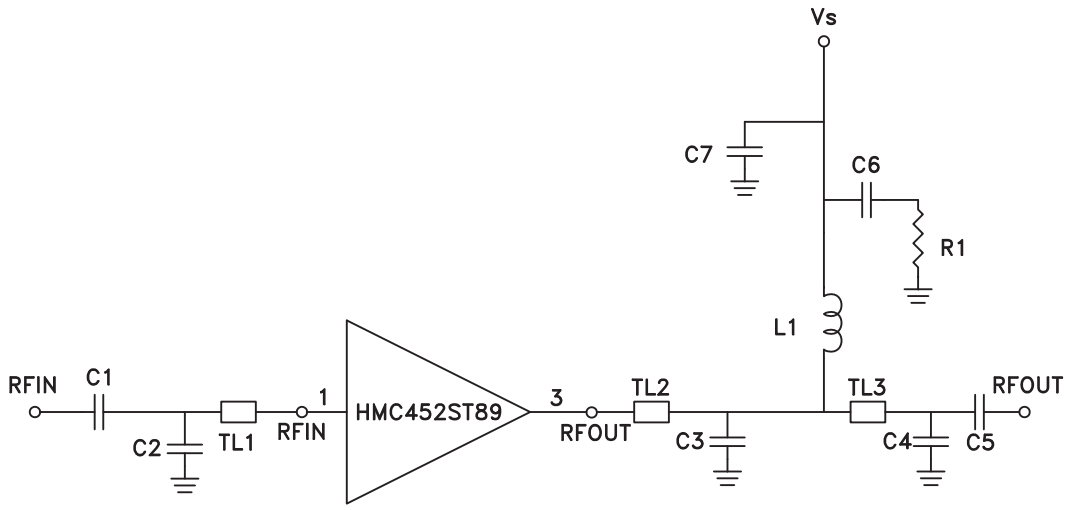
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

900 MHz Application Circuit

This circuit was used to specify the performance for 810-960 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

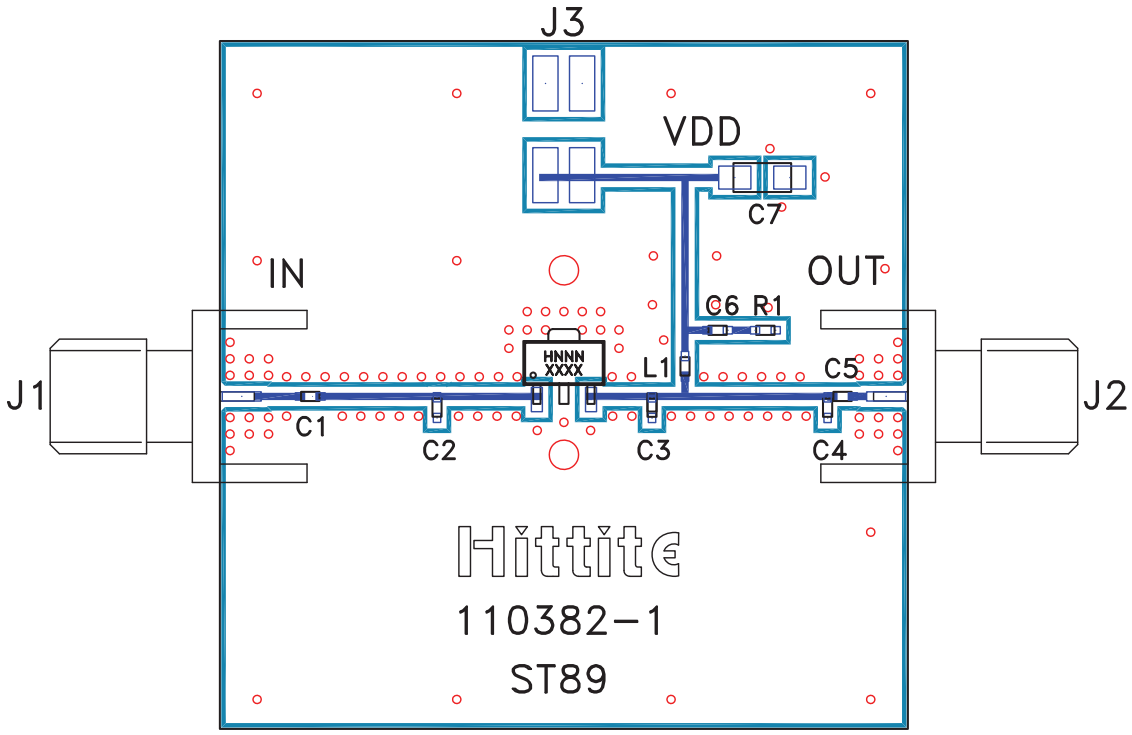


Note: C2 should be placed as close to pins as possible.

	TL1	TL2	TL3
Impedance	50 Ohm	50 Ohm	50 Ohm
Physical Length	0.21"	0.13"	0.38"
Electrical Length	11°	7°	20°
PCB Material: 10 mil Rogers 4350, Er = 3.48			

Recommended Component Values	
C1	27 pF
C2	6.8 pF
C3	2.2 pF
C4	4.7 pF
C5	5.6 pF
C6	100 pF
C7	2.2 µF
L1	20 nH
R1	5.1 Ohm

900 MHz Evaluation PCB



List of Materials for Evaluation PCB 110384-900 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	27 pF Capacitor, 0402 Pkg.
C2	6.8 pF Capacitor, 0402 Pkg.
C3	2.2 pF Capacitor, 0402 Pkg.
C4	4.7 pF Capacitor, 0402 Pkg.
C5	5.6 pF Capacitor, 0402 Pkg.
C6	100 pF Capacitor, 0402 Pkg.
C7	2.2 µF Capacitor, Tantalum
L1	20 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC452ST89 / HMC452ST89E Linear Amp
PCB [2]	110382 Evaluation PCB, 10 mils

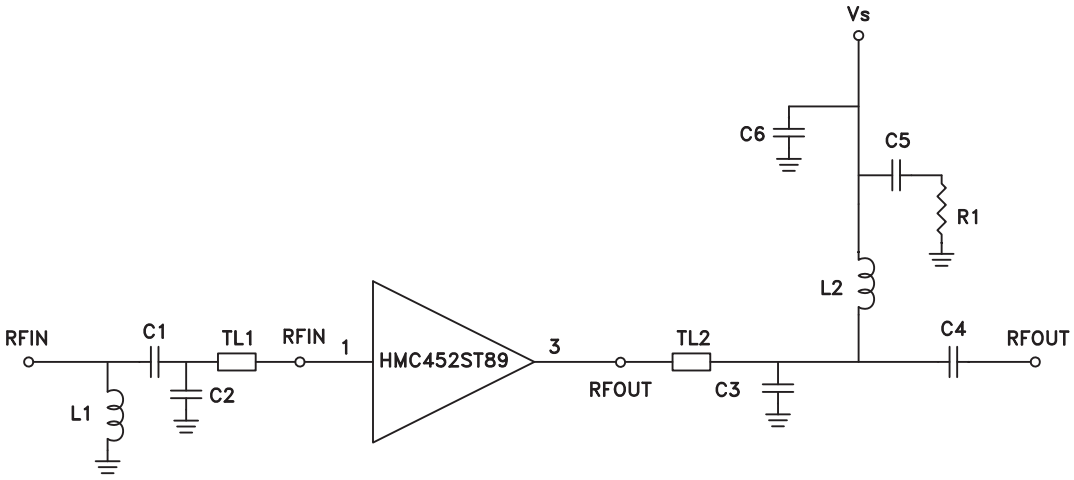
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

1900 MHz Application Circuit

This circuit was used to specify the performance for 1710-1990 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

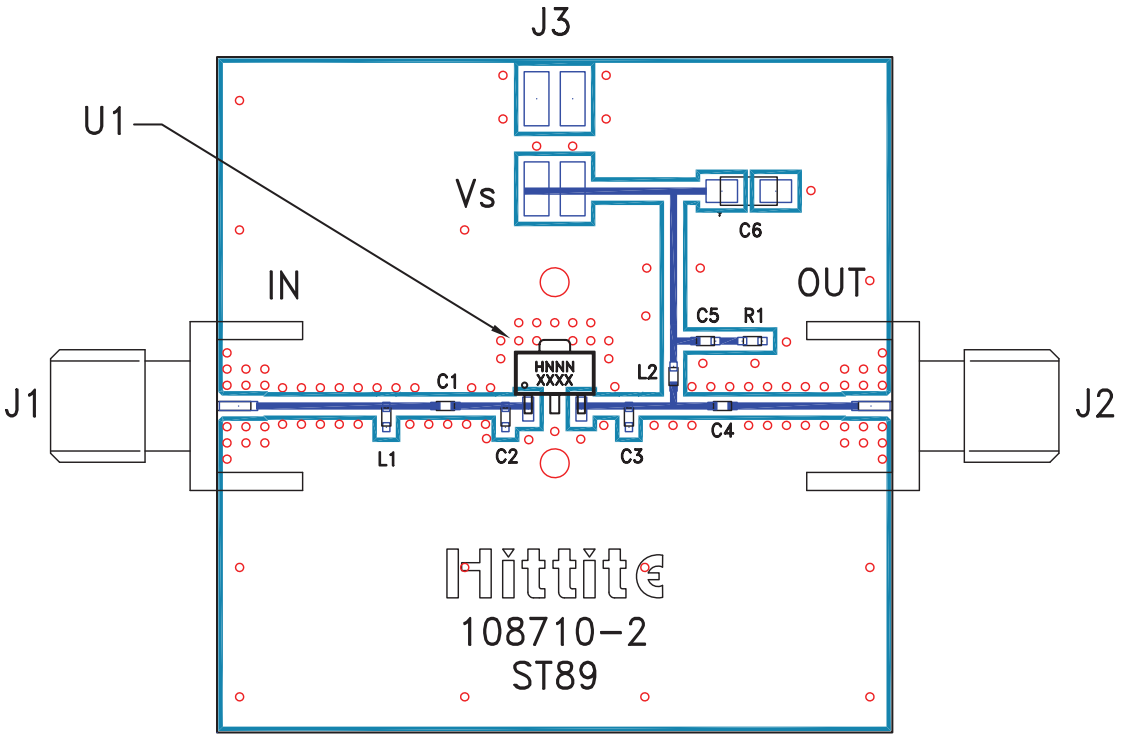


Note: C2 should be placed as close to pins as possible.

	TL1	TL2
Impedance	50 Ohm	50 Ohm
Physical Length	0.04"	0.10"
Electrical Length	4°	11°
PCB Material: 10 mil Rogers 4350, Er = 3.48		

Recommended Component Values	
C1	3 pF
C2	2 pF
C3	3.3 pF
C4	15 pF
C5	100 pF
C6	2.2 µF
L1	10 nH
L2	12 nH
R1	5.1 Ohm

1900 MHz Evaluation PCB



List of Materials for Evaluation PCB 108712-1900 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	3 pF Capacitor, 0402 Pkg.
C2	2 pF Capacitor, 0402 Pkg.
C3	3.3 pF Capacitor, 0402 Pkg.
C4	15 pF Capacitor, 0402 Pkg.
C5	100 pF Capacitor, 0402 Pkg.
C6	2.2 µF Capacitor, Tantalum
L1	10 nH Inductor, 0402 Pkg.
L2	12 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC452ST89 / HMC452ST89E Linear Amp
PCB [2]	108710 Evaluation PCB, 10 mils

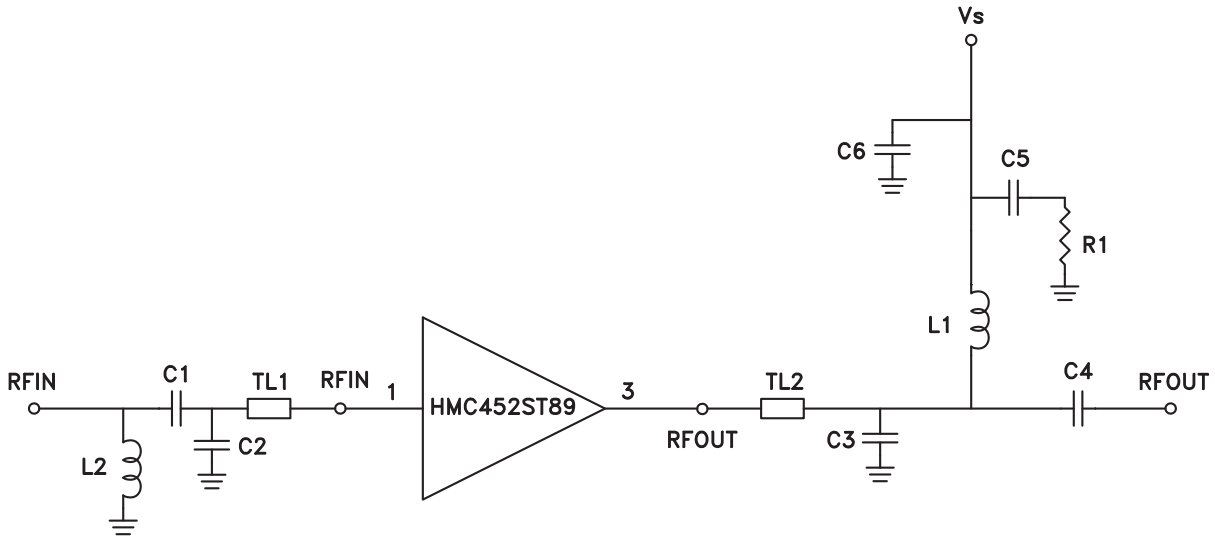
[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

2100 MHz Application Circuit

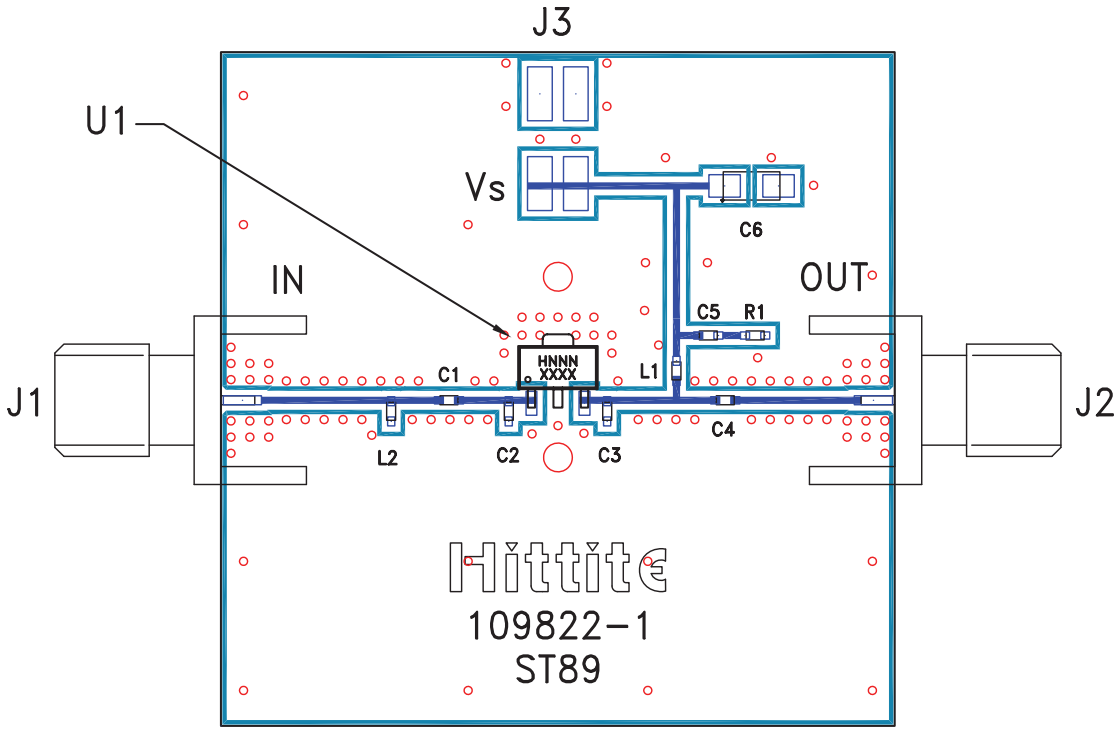
This circuit was used to specify the performance for 2010-2170 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



	TL1	TL2
Impedance	50 Ohm	50 Ohm
Physical Length	0.04”	0.04”
Electrical Length	5°	5°
PCB Material: 10 mil Rogers 4350, Er = 3.48		

Recommended Component Values	
C1	3 pF
C2	2 pF
C3	3.3 pF
C4	15 pF
C5	100 pF
C6	2.2 µF
L1	12 nH
L2	10 nH
R1	5.1 Ohm

2100 MHz Evaluation PCB



List of Materials for Evaluation PCB 109824-2100 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	3 pF Capacitor, 0402 Pkg.
C2	2 pF Capacitor, 0402 Pkg.
C3	3.3 pF Capacitor, 0402 Pkg.
C4	15 pF Capacitor, 0402 Pkg.
C5	100 pF Capacitor, 0402 Pkg.
C6	2.2 µF Capacitor, Tantalum
L1	12 nH Inductor, 0402 Pkg.
L2	10 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC452ST89 / HMC452ST89E Linear Amp
PCB [2]	109822 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

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- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».

AVIC JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).

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